

A Maxim Integrated Products Brand

PHY2078

125Mbps – 2.5Gbps FTTx Burst Mode Laser Driver / Postamplifier

Features

- Burst-Mode common anode laser driver with up to 80mA modulation and 90mA bias current
- 7ns output switching in Burst Mode
- Power saving mode with zero bias and modulation current between bursts
- Closed or open loop bias mode with temperature lookup table
- Temperature compensated modulation current
- Limiting amplifier with programmable low pass filter and output swing
- Device settings stored in external 2k EEPROM

Applications

- GPON
- **GEPON**
- BPON

Description

The PHY2078 is a combined burst mode laser driver and limiting amplifier for use within fiber optic modules for FTTx applications. Used with the PHY1095 or PHY1097 transimpedance amplifiers and a low cost serial EEPROM it forms a complete PON diplexer silicon solution.

The transmit block includes a high frequency modulator and a bias current generator. The bias current can be controlled either by a fast settling APC loop or in open loop mode which uses a temperature lookup table.

The receiver includes a limiting amplifier with programmable bandwidth. A Signal Detect/Loss Of Signal function is implemented using the input signal modulation amplitude with user selectable threshold and hysteresis.

Operating with a 3.3V supply and rated from -40 to +95°C ambient, the PHY2078 is housed in a 32pin, 5x5mm, RoHS compliant, TQFN package.

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4. Functional Description

4.1. Overview

Figure 9 - PHY2078 Functional Overview

4.2. Receiver Features

The PHY2078 receiver section consists of an Automatic Gain Control (AGC) input amplifier, which is followed by a programmable low pass filter. The filtered signal is passed to a limiting stage and the receiver output is a CML driver. Offset cancellation is provided by DC-feedback.

A Signal Detect (SD)/Loss Of Signal (LOS) alarm is provided to detect if the amplitude of the AC-signal at the receiver input is below a programmable threshold. For a transimpedance amplifier with a constant gain, the LOS threshold corresponds to a particular Optical Modulation Amplitude (OMA).

4.2.1. Receiver Input Stage

The receiver input stage includes internal 50Ω single-ended termination resistors and is designed to be AC-coupled to the transimpedance amplifier.

By default the receiver is non-inverting; however, to simplify the PCB layout of differential signals the polarity of the data can be inverted by setting RX_POLARITY (C3h, RX_LIMITER, bit 1) to '1'.

4.2.2. Receiver Filter

The programmable low pass filter provides band limiting in the receive signal path and can be used to improve the system sensitivity when a higher bandwidth TIA is used. The bandwidth of the filter is set to 0.7 x signal data rate selected and is controlled by a 3-bit control word as follows:

	Bit		Data Rate	
2				
			125/155Mbps	
			622Mbps	
			Reserved	
			1.250Gbps	
			2.488Gbps	

Table 1- Receive Filter Data Rates

The 3-bit control word is set in the RATE_SELECT register (C4h, RX_FILTER, bits 2:0).

4.2.3. Receiver CML Output Stage

The CML output stage has two slew rate settings, selected by CML_SLEW (C5h, RX_DRIVER, bit 1). The switching speed can be reduced in order to minimise electromagnetic radiation by setting CML_SLEW to a '1'. Setting CML_SLEW to '0' maximises the slew rate of the output.

The signal swing can also be adjusted. Setting CML_LEVEL to '0' (C5h, RX_DRIVER, bit 0) results in a higher receiver differential output swing. Setting CML_LEVEL to '1' results in a reduced output swing.

RXOUT+/- can also be disabled by setting RX_SQUELCH to a '1' (C2h, RX_AGC, bit 2).

The PHY2078 can automatically disable RXOUT+/- if a LOS condition is detected. To enable this function LOS TO SQUELCH should be set to '1' (C2h, RX AGC, bit 3).

In both cases the output termination remains as 50Ω but a logical '0' is output on RXOUT+/-.

Figure 10 - LOS Detection

Signal Detect (SD) or Loss of Signal (LOS) is detected by measuring the optical modulation amplitude (OMA).

The signal amplitude measured at RXIN+/- is compared to an analog threshold level set by the OMA_DAC register (D9h, OMA_DAC). If the received signal amplitude does not exceed the threshold then the LOS pin is asserted and the LOS indicator bit is set (ECh, HWARE_SENSE_STATUS, bit 3).

The polarity of the LOS pin and register indicator bit are controlled by MUX_POLARITY (C6h, RX_MUXPOL, bit 0). If MUX_POLARITY is set to '0' then the LOS pin is set high during a loss of signal condition. Conversely, if MUX POLARITY is set to '1' then the LOS pin is set high when a signal is detected.

LOS detection has hysteresis, the level of which can be selected by OMAHYSTSEL (C6h, RX_MUXPOL, bit 1). If OMAHYSTSEL is set to '0' then 3dB of hysteresis is used. If OMAHYSTSEL is set to '1' then 4dB of hysteresis is used.

Table 2 - LOS DAC Characteristics

4.2.5. Voltage Reference

The PHY2078 includes a temperature stable 1V reference source which provides the bias for the internal analog circuitry. The reference voltage is set using an internal resistor RINTERNAL (CEh, DAC_PWRD, bit 5) to 1. The accuracy of the reference voltage using the internal resistor is $+/-10\%$.

4.3. Transmitter features

The transmitter input buffer provides the necessary drive to the laser driver output stage. It includes an internal high impedance bias network and is designed to be DC or AC-coupled. For high frequency applications an external termination network must be implemented. See section 7 for more interfacing details.

The laser driver output is designed to drive lasers in the common anode configuration using either AC- or DC-coupling. For burst mode operation DC-coupling must be used.

The laser driver circuit delivers a maximum peak to peak modulation current of 80mA measured at the device output pin LASER+.

By default the transmitter is non-inverting; however, to simplify the PCB layout of differential signals the polarity of the data can be inverted by setting TX_POLARITY (CAh, TX_DBUFF, bit 0) to '1'.

4.3.1. Modulation Current Control

Figure 11 - Modulation Current Generation

The modulation current can be either set by a constant register value or controlled by a temperature indexed look-up table (LUT).

If MOD TEMP_DISABLE is set to '1' (D0h, TX_BIASLOOP_CONTROL, bit 7) then the modulation DAC is set directly from a register (D4h, MOD_DAC).

If MOD TEMP DISABLE is set to '0' then a 64 byte LUT is used to set the modulation DAC. The LUT is indexed by the temperature ADC (E1h, TEMP_ADC_VALUE), where the index is given by:

Index = (temperature ADC \times 64)/255.

The values of the LUT reside in the EEPROM, between addresses 80h (lowest temperature entry) and BFh (highest temperature entry), and are transferred at start up to on-chip registers.

The active setting for the modulation DAC can be observed by reading MOD_DAC_OBSERVE (F0h).

Table 3 - Modulation DAC Characteristics

4.3.2. Bias Current Control

Figure 12 - Bias Current Generation

The PHY2078 can operate with open or closed loop bias control. In either mode the current setting for the bias DAC can be observed by reading BIAS_DAC_OBSERVE (EFh).

The bias current level is measured using an on-chip ADC and can be observed by reading BIAS_ADC_VALUE (E2h).

Table 4 - Bias ADC Characteristics

Table 5 - Bias DAC Characteristics

4.3.3. Open Loop

If OPENLOOP is set to '1' (CCh, TX_BIASLOOP, bit 4) the bias generator operates in open loop mode. The bias current can be either set by a constant register value or controlled by a temperature indexed lookup table (LUT).

If BIAS_TEMP_DISABLE is set to '1' (D0h, TX_BIASLOOP_CONTROL, bit 6) then the bias DAC is set directly from a register (D8h, BIAS_DAC).

If BIAS TEMP DISABLE is set to '0' then a 128 byte LUT is used to set the bias DAC. The LUT is indexed by the temperature ADC (E1h), where the index is given by:

Index = (temperature ADC x 128)/255.

The values for the LUT reside in the EEPROM, between addresses 00h (lowest temperature entry) and 7Fh (highest temperature entry), and are loaded into on-chip registers at start up.

In open loop mode the MPD device pin is not used and can be left unconnected.

Figure 13 - Bias Current Generation, Open Loop

4.3.4. Closed Loop

If OPENLOOP is set to '0' the bias generator operates in closed loop mode. The average output power of the laser is controlled by a digital mean power control loop. The feedback to the control loop is provided by a monitor photodiode connected to MPD. The current from the monitor photodiode is compared with a reference current (Imonset). This is output by the mean power DAC and controlled by MON_DAC (D5h).

In order to provide the required resolution and range the mean power DAC has three step sizes as shown in the table below.

Table 6 - Mean Power DAC Characteristics

The 3dB frequency of the digital mean power control loop is controlled by the size of a prescaling counter and can be determined (in Hertz) by:

 F_{3dB} = (Kfactor x 692) / (M x Imonset)

where Kfactor = laser current to monitor photodiode current coupling coefficient Imonset = desired monitor photodiode current (A) $M = 2^{(2 \times \text{prescale}_ \size)}$

Prescale_size is set by (D0h, TX_BIASLOOP_CONTROL, bits 2:0).

Figure 14 - Bias Current Generation, Closed Loop

4.3.5. Initial Start-up

At power up or after TX_DISABLE is de-asserted the PHY2078 can use a fast startup algorithm to quickly settle the mean power control loop to the desired bias level. The algorithm can only be invoked in closed loop, DC-coupled mode and after it has completed the low bandwidth digital mean power control loop takes over to maintain the optical output power. The details of the startup algorithm and its parameters are described in section 8.5.

4.3.6. Burst Mode and Power Saving

In burst mode operation de-asserting the BEN+/- inputs causes the mean power control loop to pause and turning off the bias current. This mode of operation saves power compared with burst laser drivers that maintain a diverted bias current during burst off. The saving can be up to 95% of the bias and modulation current during burst off periods for a system with a split ratio of 16:1. Re-asserting the BEN+/ input re-enables the modulation current and releases the mean power control loop such that the bias current from the end of the preceding burst is used as the start point for the next burst. The burst on/off timings are detailed in the electrical timings section.

The polarity of the BEN+/- inputs can be inverted using BURST_POLARITY (CAh, TX_DBUFF, bit 2).

4.3.7. Laser Driver Setup

There is a trimming network on the output driver which adjusts the time constant of the output damping on LASER+/-. It is controlled by the value in TX_DRIVER_CAP (C9h). Table 7 contains the valid register settings and the damping time constant they set, where RC = 16.8ps.

4.3.8. Performance Monitoring

As part of its main control loop the PHY2078 monitors temperature and transmit bias current via an onchip ADC. The ADC values are reported via registers TEMP_ADC_VALUE (E1h) and BIAS_ADC_VALUE (E2h).

The user has the option of using the measured values of temperature and bias current to set alarm bits. These are generated if the values measured are above or below programmable limits. The conditions are shown in Table 8 and 9 below.

Table 8 - Over and under temperature alarm generation

An out of range monitored temperature (TEMP_MAX_ERROR is set to '1' or TEMP_MIN_ERROR is set to '1') will cause a TX_FAULT condition to be raised.

An out of range monitored bias current (BIAS_MAX_ERROR is set to '1' or BIAS_MIN_ERROR is set to '1') will cause a TX_FAULT condition to be raised.

The response of the PHY2078 to an alarm condition is described in Section 4.4.

4.4. Laser Safety Features

Figure 15 - Transmit Fault Generation

The laser safety circuit monitors the device for potential faults. If a fault is detected the pin TX_FAULT is asserted.

The register bit TX_FAULT (EAh, STATUS, bit 3) reflects the status of the pin TX_FAULT.

Using bias alarm requires FAULT_LATCH_ENABLE to be set to 0.

A transmit fault can be raised by the following:

1. The temperature monitor detects that the measured temperature has gone out of range (see section 4.3.8).

2. The bias current monitor detects that the measured transmit bias current has gone out of range (see section 4.3.8).

- 3. The internal controller logic detects that a DMA from EEPROM has failed (see section 5.1)
- 4. The SOFT_TX_FAULT bit (E8h, TX_DISABLES, bit 2) is set to '1'
- 5. The voltage reference monitoring circuit detects that the reference voltage is incorrect
- 6. The supply monitoring circuit detects that the power supply voltage is incorrect

If FAULT LATCH $EN = '0'$ (DAh, ALARM ENABLE, bit 4) then a transmit fault condition will cause the TX FAULT pin to stay asserted even if the fault condition goes away. The pin will stay asserted until either the chip is power cycled or the pin TX_DISABLE is set to '1' or the register SOFT_TX_DISABLE is set to '1' (E8h, TX_DISABLES, bit 1) or FAULT_LATCH_EN is set to '1'.

If FAULT_LATCH_EN = '1' then the TX_FAULT pin is deasserted when the fault condition goes away.

Figure 16 - Transmit Shutdown Generation

The PHY2078 contains circuitry to shutdown the transmitter bias and modulation current if a problem is detected. The conditions to cause a shutdown are:

- 1. The voltage reference monitoring circuit detects that the reference voltage is incorrect
- 2. The supply monitoring circuit detects that the power supply voltage is incorrect

3. The SOFT_TX_DISABLE bit (E8h, TX_DISABLES, bit 1) is set to '1'

4. The internal controller logic has not successfully completed its initialisation (see section 5.1)

5. The pin TX_DISABLE is asserted

6. TX_FAULT is active and FAULT_POWERDOWN_EN = '1' (DAh ALARM_EN bit 5)

If a shutdown condition occurs the modulation and bias currents are disabled. Conditions 1-4 can be disabled from contributing to shutdown by setting EYE_SAFETY_DISABLE = '1' (CCh, TX_BIASLOOP, bit 0). This feature should be used with great caution.

The polarity of the TX DISABLE pin can be inverted by setting TX DISABLE POLARITY (CCh, TX_BIASLOOP, bit 7).

The register bit TX_SHUTDOWN (EAh, STATUS, bit 2) reflects the status of the shutdown circuit.

The register bit TX DISABLE (ECh, HWARE SENSE STATUS, bit 4) reflects the status of the pin TX_DISABLE (after optional inversion using TX_DISABLE_POLARITY).

4.5. Temperature Measurement

The PHY2078 uses an on-chip 8 bit ADC to perform a temperature measurement once per iteration of its main control loop (approximately every 10ms). The measured ADC value can be read from register TEMP_ADC_VALUE (E1h). This measurement can be used to control the modulation and bias currents.

The temperature is determined by forcing two different currents through a diode connected transistor (base and collector shorted together) measuring the resulting voltage difference, ΔV_{BE} . This voltage is directly proportional to the temperature. If NPN_INTERNAL is set to '1' (CBh, TX_TEMPSENSE, bit 1) then an on-chip transistor is used. In this case pin TSENSE should be left unconnected. If NPN_INTERNAL is set to '0' then the ADC uses a suitable external device connected to pin TSENSE. The transistor can be any standard npn silicon transistor with a beta > 100, however Phyworks recommends using a BC847B or similar. Where accuracy improvement is needed calibration and averaging of the temperature sensor values are recommended or use of an external temperature sensor such as that in a microcontroller.

SELECT 3I (CBh, TX_TEMPSENSE, bit 0) and VTOISLOPESEL (CBh, TX_TEMPSENSE, bits 2 - 3) can be adjusted, depending on the external device used, to ensure that the PHY2078 is capable of measuring the required range of temperatures.

The temperature sensor operating range is shown in Table 10.

Figure 17 – Temperature sensor functional block diagram

Parameter	Comment	Symbol	Min	Typical	Max	Units
Temperature			-45		90	°C
ADC slope	VTOISLOPESEL = 00			0.67		°C/bit
	VTOISLOPESEL = 01			1.32		°C/bit
	VTOISLOPESEL = 10			1.63		°C/bit
	VTOISLOPESEL = 11			2.25		°C/bit
TSENSE delta input voltage	VTOISLOPESEL = 00	ΔV_{BF}	50		100	mV

Table 10 – Internal Temperature Measurement

5. Control Interface

Figure 18 - Serial interfaces to internal registers

The host communicates with the PHY2078 and the EEPROM via the slave Two Wire Interface (TWI) pins of the PHY2078. Slave addresses A0h and A2h are supported, register settings for PHY2078 are stored in A2h. If a transaction arriving at the slave interface is addressed to A2h, then the PHY2078 examines the register address in order to decide how the transaction should be processed (see address map in figure 19).

- If the register is implemented in EEPROM only (addresses 00h to BFh) then the transaction is forwarded to the EEPROM via path 4 in figure 18. There is a direct combinational logic path between the slave and master interfaces which makes the PHY2078 transparent when transactions from the host are forwarded to the EEPROM.
- If the register is only implemented internally to the PHY2078 (addresses E0h to FFh) then the data is written to or read from the registers inside the PHY2078 (path 3).
- If the register is implemented both internally and EEPROM (addresses C0h to DFh) then the PHY2078 checks the INTERNAL_ACCESS register bit (E7h INTERNAL bit 1) to determine whether the host wishes to access the EEPROM or internal registers. Set INTERNAL ACCESS is set to '1' to access the internal registers and '0' to access the EEPROM.

When the PHY2078 comes out of reset, the state machine uses the master two wire interface to read configuration bytes out of EEPROM. This data is used to configure the internal registers of the device (path 1).

Subsequently, during normal operation the state machine will use the master interface to periodically access look-up table and alarm threshold information stored in the EEPROM (path 2). In order to prevent collisions between state machine and host accesses to EEPROM, the host must always stop the state machine before attempting to access the EEPROM by setting an internal register bit, SM_STOP, to '1' (E7h, INTERNAL, bit 0). When the host has completed its transactions with the EEPROM it must set SM STOP to '0' to allow normal operation of the state machine to resume. If the host attempts to access the EEPROM when SM_STOP is set to '0' then writes are ignored and reads return a zero.

5.1. Boot Sequence

Figure 20 - PHY2078 Boot Sequence

At power up the PHY2078 attempts to read a number of bytes of configuration information from an external EEPROM into its internal registers.

If the read fails due to a problem on the TWI, such as a read not being correctly acknowledged, the state machine sets register bit BOOT_FAIL_E to '1' (EDh, DEBUG_EVENTS, bit 2), raises a transmit fault condition and remains in an error state.

The first two bytes read from EEPROM, C0h and C1h, are compared against a data integrity number (C35Ah). If the compare fails, the state machine sets register bit INTEGRITY_FAIL_E to '1' (EDh, DEBUG_EVENTS, bit 4), raises a transmit fault condition and remains in an error state.

In the error state the host is able to configure the internal registers of the PHY2078 using the slave TWI. When it has completed configuration the host must clear the active error(s) by writing a '1' to the corresponding bit(s). When the state machine sees that the error bit(s) are cleared it clears the transmit fault condition.

The state machine sets the register BOOT_COMPLETE_E (EDh, DEBUG_EVENTS, bit 1) to indicate that the boot process is complete and then enters the main control loop.

5.2. Main Control Loop

Figure 21 - PHY2078 Main Loop Function

A loop timer is implemented in the state machine to ensure that the start of each iteration of the loop is separated by 10ms.

When the timer has expired the state machine reads the on-chip ADC to obtain temperature and bias current levels, reads alarm levels out of EEPROM and sets/clears performance alarms accordingly.

The state machine then sets the modulation current and bias current.

At the end of the first iteration of the loop after boot-up the state machine clears transmit disable to enable the transmit data path.

5.3. 2-wire Serial Interface

The PHY2078 has a pair of 2-wire serial interfaces: a slave for interfacing to a host for module setup and programming, and a master for interfacing to an external EEPROM and for device configuration after reset. Both interfaces communicate using the protocol described in this section.

5.3.1. Framing and Data Transfer

The two-wire interface comprises a clock line (SCL) and a data line (SDA). When the bus is idle both are pulled high within the PHY2078 by 8kΩ pull-ups.

An individual transaction is framed by a start condition and a stop condition. A start condition occurs when a bus master pulls SDA low while the clock is high. A stop condition occurs when the bus master allows SDA to transition low-to-high when the clock is high. Within the frame, the master has exclusive control of the bus. The PHY2078 supports REPEAT START conditions whereby the master may simultaneously end one frame and start another without releasing the bus by replacing the STOP condition with a START condition.

Within a frame, the state of SDA may only change when SCL is low. A data bit is transferred on a low-tohigh transition of SCL. Data is arranged in packets of 9 bits. The first 8 bits represent data to be transferred (most significant bit first). The last bit is an acknowledge bit. The recipient of the data holds SDA low during the ninth clock cycle of a data packet to acknowledge (ACK) the byte. Leaving SDA to float high on the ninth bit signals a not-acknowledged (NACK) condition. The interpretation of the acknowledge bit by the sender will depend on the type of transaction and the nature of the byte being received.

5.3.2. Device Addressing

The first byte to be sent after a START condition is an address byte. The first seven bits of the byte contain the target slave address (msb first). The eighth bit indicates the transaction type – '0' = write, '1' = read. Each slave interface on the bus is assigned a 7-bit slave address. If no slave matches the address broadcast by the master then SDA will be left to float high during the acknowledge bit and the master receives a NACK. The master must then assert a STOP condition. If a slave identifies the address then it acknowledges the master and proceeds with the transaction identified by the type bit.

Figure 22 - Address decoding example – slave not available

5.3.3. Write Transaction

Figure 23 shows an example of a write transaction. The address byte is successfully acknowledged by the slave, and the type bit is set low to signify a write transaction. After the acknowledge the master sends a single data byte. All signalling is controlled by the master except for the SDA line during the acknowledge bits. During the acknowledge the direction of the SDA line is reversed and the slave pulls SDA low to return a '0' (ACK) to the master.

If the slave is unable to receive data then it should return a NACK after the data byte. This will cause the master to issue a STOP and thus terminate the transaction.

The PHY2078 interprets the first data byte as a register address. This will be used to set an internal memory pointer. Subsequent data bytes within the same transaction will then be written to the memory location addressed by the pointer. The pointer is auto-incremented after each byte. There is no limit to the number of bytes which may be written in a single burst to the internal RAM of the PHY2078. If, however, the write access is destined for the EEPROM the requirements of page writes specified for the EEPROM apply.

If the slave is not ready to receive a byte then it may hold SCL low immediately after the acknowledge bit. When SCL is released the master starts to send the next byte. This is known as clock stretching. The PHY2078 slave interface will not clock stretch at up to 100 kHz SCL frequency.

5.3.4. Read Transaction

Figure 24 - Read transaction

Figure 24 shows an example of a 2 byte read transaction. The address byte is successfully acknowledged by the slave, and the type bit is set high to signify a read. After the ACK the slave returns a byte from the location identified by the internal memory pointer. This pointer is then auto-incremented. The slave then releases SDA so that the master can ACK the byte. If the slave receives an ACK then it will send another byte. The master identifies the last byte by sending a NACK to the slave. The master then issues a STOP to terminate the transaction.

Thus, to implement a random access read transaction, a write must first be issued by the master containing a slave address byte and a single data byte (the register address) as shown in Figure 23. This sets up the memory pointer. A read is then sent to retrieve data from this address (see Figure 24).

6. Register Map

Where a single power-on reset (PoR) value is shown for a range of addresses, that value applies to all bytes in the range. Note that the power on reset values may be overwritten during initialisation from the EEPROM.

For registers containing a single 8-bit field, the most significant bit of the field is stored in bit 7 of the register byte.

Note that 'reserved' or 'internal use only' register bits are specified as read only. These registers should not changed from their PoR default settings.

- R Bit is read only. A write to this bit via the TWI will have no effect. The value may be changed by the device itself as part of its normal operation
- R/W Bit is readable and writable via the TWI. The value will not be changed by the device itself except under a device reset.
- E Bit is readable via the TWI. The bit may be set by the device itself as part of its normal operation. Once set the bit may be cleared by writing a '1' via the TWI. Writing a '0' via the TWI has no effect.

The following registers exist only in the internal registers of the device. The corresponding addresses in EEPROM are unreachable. Therefore a TWI transaction to these addresses will target the internal device registers regardless of the setting of 'INTERNAL_ACCESS'.

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7. Simplified Interface Models

Figure 25 - Transmit input structure Figure 26 - Transmit output structure

Figure 27- Receive input structure Figure 28- Receive output structure

 Figure 31 - LOS/TX_FAULT output

Figure 29 - MPD input structure Figure 30 - Laser bias output structure

8. Applications Information

8.1. PHY2078 in an ONU application

Figure 32 – Typical ONU Application Diagram

Figure 32 shows the general connectivity required with the PHY2078 to implement a Small Form Factor (SFF) type application, as used in GEPON systems.

The PHY2078 post amplifier is AC-coupled to the TIA in the ROSA. DC-coupling is required at the transmitter input and the laser output in order to support burst-mode operation. Exact implementation of the matching network varies with the actual laser used. When used in open-loop mode, no Monitor Photo Diode (MPD) will be required in conjunction with the Laser. When used in closed loop mode, the MPD is connected to the MPD pin on the PHY2078.

Module settings are stored in the EEPROM, and can be programmed using the EEPROM_SDA/SCL interface. Figure 32 shows the use of an external temperature sensor (diode-connected NPN-transistor) this should not be used when the internal temperature sensor is used.

8.1.1. Reference Design and Firmware

Checking for the latest reference design and firmware to support PHY2078 is recommended. The documents can be downloaded from the Phyworks website or by contacting Phyworks representatives.

8.2. Power Supply Connections

The PHY2078 has been designed as a low power device. In order to achieve low operating power consumption the transmitter and receiver circuitry in the PHY2078 share some common internal bias circuitry. This requires that the PHY2078 transmitter and receiver be powered up together for correct operation.

8.2.1. Power Supply Filtering

Although the Tx VDDs and Rx VDDs should be powered together and therefore, ultimately be connected at a common node, it is beneficial to separately filter the power supplies for the Tx VDD and Rx VDD supplies. Separately filtering the transmitter and receiver supplies off chip will reduce power supply noise and cross talk between the transmitter and receiver – it is generally good practice to separately filter and decouple the individual supplies on any multifunction IC.

In addition to supplying separately filtered supplies to the Tx VDDs and Rx VDDs of the PHY2078, it is recommended that any other ICs and digital circuitry connected to the PHY2078 in an application environment (e.g. SFF module) be suitably filtered and decoupled. An example of this would be to supply a filtered digital supply for an external MCU.

Figure 33 – Recommended power supply connections and filtering.

8.3. Burst Enable and TX Input connection options

The PHY2078 supports various modes of interfacing to the transmit data (TXIN+/-) and burst enable (BEN+/-) inputs providing the signal voltage and common-mode voltage levels are within the valid range specified in figure 4. Some common examples are shown in figures 34-36 below.

Figure 34 - DC-Coupled CML interface for TXIN and BEN

Figure 35 - DC-Coupled LVPECL interface for TXIN and BEN

Figure 36 – Single-ended CMOS/LVTTL interface for BEN

8.4. Laser Connection – DC-Coupled

Figure 37 - DC-Coupled Laser Application Diagram

Figure 37 shows a typical DC-coupled application. DC current is provided to the output stage via a resistive network. The AC impedance to ground of the LASER+ pin should be approximately 50Ω to properly terminate that output. R_{SERIES} is used to match the laser impedance. It may also be necessary to use a RC snubbing circuit connected in parallel with the laser to reduce any ringing caused by series inductance in the packaging. A 10 Ω resistor, R_{BLOCK}, is used to isolate the output stage from the capacitive loading of the BIAS pin. In this mode, the BIAS pin can sink up to 80mA of current. For burstmode applications ferrites should not be used as they will not allow the bias to settle correctly.

8.5. Mean Power Control Loop Startup Algorithm

At power up or after TX_DISABLE is de-asserted the PHY2078 can use a fast startup algorithm to quickly settle the mean power control loop to the desired bias level. After the algorithm has completed the low bandwidth digital mean power control loop takes over to maintain the optical output power. The algorithm can only be invoked in closed loop, DC coupled mode, for AC coupled applications the startup algorithm must be disabled, and the mean power control loop will settle at a rate determined by its bandwidth.

Figure 38 - Closed Loop Fast Start-up Algorithm

The fast start-up algorithm contains three stages as shown in Figure 38.

Stage 1 begins at power-up or after TX_DISABLE is de-asserted and completes when the PHY2078 has successfully loaded its operating parameters from the companion EEPROM. During this stage the data path is disabled and the modulation outputs balanced such that $I_{\text{MOD}}/2$ flows into both LASER+ and LASER-.

Stage 2 is a ramp sequence which starts with an initial step (A) approximately equal to $I_{\text{MOD}}/2$ and is followed by smaller increments (B) on each cycle of the algorithm clock (64MHz). The ramp continues until an internal comparator detects that the photodiode current has exceeded the desired reference current set by MON_DAC (D5h). The finite delay present in the system between setting a bias current and the monitor photodiode current settling means that the bias level at the end of the ramp sequence will have overshot the desired operating point.

Stage 3 is a binary search sequence used to quickly and accurately acquire the mean power level. This can take up to eight steps. Control of the bias current is transferred to the low frequency mean power control loop and the data path is enabled at the end of the binary search sequence.

There are various parameters within each of the stages which can be controlled by the user:

$A =$ IMODCODE x 0.2662

Where A is in mA and IMODCODE is the value applied to the modulation DAC. If a modulation lookup table is used IMODCODE will be dependant on temperature, otherwise IMODECODE is equal to the value set in the MOD_DAC (D4h) register. The actual value applied to the modulation DAC is visible in MOD_DAC_OBSERVE (F0h)

B = IMODCODE x RAMP_STEP_FACTOR x 0.001512

Where B is in mA and the recommended setting for RAMP_STEP_FACTOR (D2h) is 82d.

C = IMODCODE x BURST_START_FACTOR x 0.2662

Where C is in mA and BURST_START_FACTOR (D0h, TX_BIASLOOP_CONTROL, bits 5:4) can be set between 1 and 3, but 2 is the recommended setting.

$D = BINARY$ SEARCH_WIDTH x 1/F_{clk}

BINARY_SEARCH_WIDTH (D1h, TX_BURST_CONTROL_1, bits 2:0) has a valid range of 4 to 8, where 8 is the default and 4 represents fastest binary search time, see Table 11 for coding. F_{clk} is 64MHz, the frequency of the internal clock.

	Bit			
BINARY_SEARCH_WIDTH				

Table 11 - BINARY_SEARCH_WIDTH values

At the end of stage 2 the bias current will have exceeded the desired bias level. This overshoot can be estimated using the following equation:

Max Overshoot (mA) < $(\tau_L F_{clk} + 1)$ x RAMP_STEP_FACTOR x IMODCODE x 0.001512

Where τ_L is the delay round the APC feedback loop. For most applications this is dominated by the capacitance of the monitor photodiode (C_{PD}), so $\tau_1 \approx 250 \times C_{\text{PD}}$.

Overshoot can be reduced by lowering the value of RAMP_STEP_FACTOR however this reduction will be at the expense of a longer startup time.

The time taken for the algorithm to complete and the parameters used, are highly dependent on the optics used in the system. For most systems the default parameter values will be acceptable.

The foregoing description assumes that the burst enable signal is always asserted. However, the startup algorithm can be split over up to three bursts. The algorithm pauses while the burst enable signal is deasserted and resumes when it is re-asserted. If the algorithm has not completed after three bursts, then control of the bias current is transferred to the mean power control loop using the value reached by the algorithm at the end of the third burst. The mean power control loop settles from that point at a rate determined by its bandwidth.

The fast startup algorithm can be disabled by setting BIAS_STARTUP_BYPASS (D0h, TX_BIASLOOP_CONTROL, bit 3) to '1'. If the algorithm is disabled the bias current is initialized to zero and settles to the desired level at a rate determined by the bandwidth of the digital control loop.

Fast Startup Example

For:

```
Imod = 30mAIMODCODE = 80
BINARY_SEARCH_WIDTH=4
 BURST_START_FACTOR=2 
C_{PD} = 10pF
```
We get:

 $A = 80 \times 0.2662 = 21.3mA$ $B = 80 \times 82 \times 0.001512 = 9.9mA$ $C = 80 \times 2 \times 0.2662 = 42.6$ mA $D = 4 / Fclk = 61$ ns Max Overshoot = 11.5mA

Figure 39 - Closed Loop Fast Start-up Algorithm Example

9. Packaging

Figure 40 – 32pin TQFN Package Dimensions

PACKAGING NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.

2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.

3. N IS THE TOTAL NUMBER OF TERMINALS.

4. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 MM AND 0.30 MM FROM TERMINAL TIP.

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5. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

- 6. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 7. DRAWING CONFORMS TO JEDEC MO220.
- 8. WARPAGE SHALL NOT EXCEED 0.10 MM.
- 9. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 10. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- 11. LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION 'e', ±0.05.

For the latest package outline information and land patterns (footprints), go to www.maximic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Note: Refer to EIA/JEDEC standard JESD51 for test method and conditions

Table 12 - 32pin TQFN Package Thermal Data